



PATENT  
Atty. Docket No. 408204  
Express Mail Label No. EV206746462US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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|--------------|--------------------------------|------------------|---------------------|
| Applicant(s) | Efren M. Lacap et al.          | Examiner         | Jonathan J. Johnson |
| Serial No.   | 10/648,586                     | Group Art No.    | 1725                |
| Filed        | 26 August 2003                 | Confirmation No. | 4089                |
| For          | WAFER-LEVEL CHIP SCALE PACKAGE |                  |                     |

Mail Stop AMENDMENT  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE

Sir:

These remarks are responsive to the Office Action of 23 June 2005. Please amend the above-identified application as indicated herein:

**Written Request Pursuant to 37 C.F.R. §1.136(a)(3):**

Please accept this authorization to treat any concurrent or future reply that requires a petition for extension of time for its timely submission as though the reply incorporates a petition for extension of time for the appropriate length of time.

**An amendment to the Specification** is on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims that begins on page 3 of this paper.

**Amendments to the Drawings** begin on page 6 of this paper and include an attached sheet replacing the sheet containing FIG. 11.

**Remarks/Arguments** begin on page 7 of this paper.